

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Switching Diode

Unit: mm

DA4J101K0R

Panasonic

DA4J101K0R

Silicon epitaxial planar type

For high speed switching circuits DA4X101K in SMini4 type package

- Features
- · Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 21
- Basic Part Number : Dual DA2J101 (Parallel)
- Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

2. 0					
4	0.3				
(0. 65)(0. 0	65)				
1. Anode 1 3. Cathode 2 2. Anode 2 4. Cathode 1					
Panasonic	SMini4-F3-B				
JEITA	SC-113BB				
Code	_				

■ Absolute Maximum Ratings Ta = 25 °C

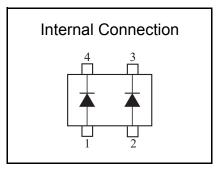
Parameter	Symbol	Rating	Unit		
Reverse voltage	VR	80	V		
Maximum peak reverse voltage		VRM	80	V	
Forward current	Single	IF(AV)	100	mA	
(Average)	Double	II-(AV)	75		
Repetitive peak	Single	IFRM	225	mA	
forward current	Double	ILLXIVI	170		
Non-repetitive peak	Single	IFSM	500	mA	
forward surge current *1	Double	IFSIVI	375		
Junction temperature		Tj	150	°C	
Operating ambient temperature		Topr	-40 to +85	°C	
Storage temperature		Tstg	-55 to +150	°C	
			•		

Note) *1: t = 1 s

Established: 2009-12-01

Revised

: 2013-06-12



Revision. 3

Switching Diode

DA4J101K0R

Panasonic

■ Electrical Characteristics Ta = 25 °C ± 3 °C

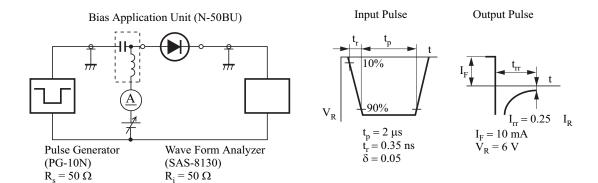
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 100 mA		0.95	1.20	V
Reverse voltage	VR	IR = 100 μA	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz		0.9	2.0	pF
Reverse recovery time *1	trr	IF = 10 mA , VR = 6 V			2	ns
		Irr = 0.25 x IR			3	

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. Absolute frequency of input and output is 100 MHz.
 - 3. *1: trr test circuit

Established: 2009-12-01

Revised

: 2013-06-12



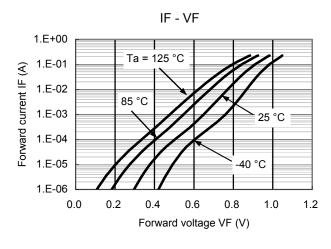
Panasonic

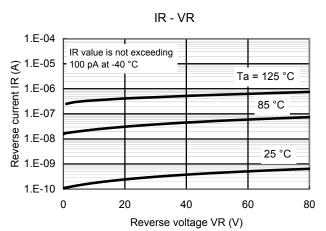
Revision. 3

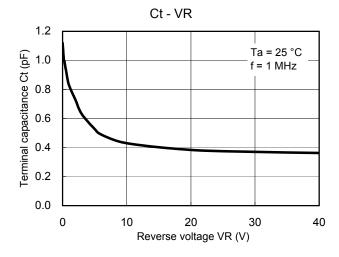
Switching Diode

DA4J101K0R

Technical Data (reference)







Established: 2009-12-01 Revised: 2013-06-12

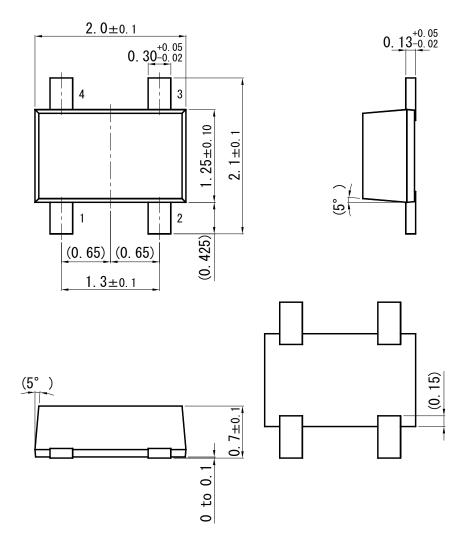
Switching Diode

DA4J101K0R

SMini4-F3-B

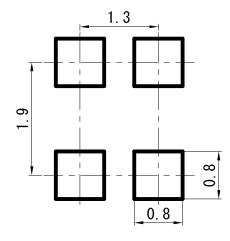
Panasonic

Unit: mm



■ Land Pattern (Reference) (Unit: mm)

Established: 2009-12-01 Revised: 2013-06-12



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